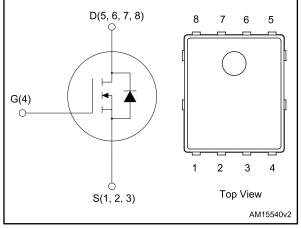


# Automotive-grade N-channel 60 V, 1.2 mΩ typ., 120 A STripFET™ F7 Power MOSFET in a PowerFLAT™ 5x6 package

PowerFLAT™ 5x6

Figure 1: Internal schematic diagram



Datasheet - production data

#### **Features**

Order code	V ds	R <sub>DS(on)</sub> max	ID
STL225N6F7AG	60 V	1.4 mΩ	120 A

- AEC-Q101 qualified
- Among the lowest R<sub>DS(on)</sub> on the market
- Excellent FoM (figure of merit)
- Low Crss/Ciss ratio for EMI immunity
- High avalanche ruggedness
- Wettable flank package

#### **Applications**

• DC-DC converter for H.E.V. (hybrid electric vehicle)

#### Description

This N-channel Power MOSFET utilizes STripFET™ F7 technology with an enhanced trench gate structure that results in very low onstate resistance, while also reducing internal capacitance and gate charge for faster and more efficient switching.

#### Table 1: Device summary

Order code Ma		Marking	Package	Packaging
	STL225N6F7AG	225N6F7	PowerFLAT <sup>™</sup> 5x6	Tape and reel

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This is information on a product in full production.

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°C/W

0.8

## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	60	V
V <sub>GS</sub>	Gate-source voltage	±20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	120	А
ID <sup>(1)</sup>	Drain current (continuous) at T <sub>c</sub> = 100 °C	120	А
I <sub>DM</sub> <sup>(1)(2)</sup>	Drain current (pulsed)	480	А
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	188	W
Tj	T <sub>j</sub> Operating junction temperature range		*0
T <sub>stg</sub>	-55 to 1		°C

#### Notes:

<sup>(1)</sup>This value is limited by package.

 $^{(2)}\mbox{Pulse}$  width limited by safe operating area

Table 3: Thermal data				
Symbol Parameter		Value	Unit	
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb		°C/W	

#### Notes:

R<sub>thj-case</sub>

 $^{(1)}\!When$  mounted on FR-4 board of 1 inch², 2oz Cu, t < 10 s.

Thermal resistance junction-case



## 2 Electrical characteristics

(Tc = 25 °C unless otherwise specified)

Table 4: On /off states						
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 1$ mA, $V_{GS} = 0$ V	60			V
IDSS	Zero gate voltage drain current	V <sub>GS</sub> = 0 V V <sub>DS</sub> = 60 V			1	μA
Igss	Gate-body leakage current	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS}$ = $V_{GS}$ , $I_D$ = 250 $\mu$ A	2		4	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS}=10~V,~I_{D}=60~A$		1.2	1.4	mΩ

#### Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	6500	-	pF
Coss	Output capacitance	$V_{DS} = 25 V, f = 1 MHz,$	-	3200	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> = 0 V		230	-	рF
Qg	Total gate charge	$V_{DD} = 30 \text{ V}, I_D = 120 \text{ A},$	-	98	-	nC
Qgs	Gate-source charge	V <sub>GS</sub> = 0 to 10 V	-	38	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14: "Test circuit for gate charge behavior").		28	-	nC

#### Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	$V_{DD} = 30 V, I_D = 60 A,$	-	41	-	ns
tr	Rise time	$R_{G} = 4.7 \Omega, V_{GS} = 10 V$	-	45	-	ns
t <sub>d(off)</sub>	Turn-off delay time	(see Figure 13: "Test circuit for resistive load switching times"	-	68	-	ns
t <sub>f</sub>	Fall time	and Figure 18: "Switching time waveform").	-	35	-	ns



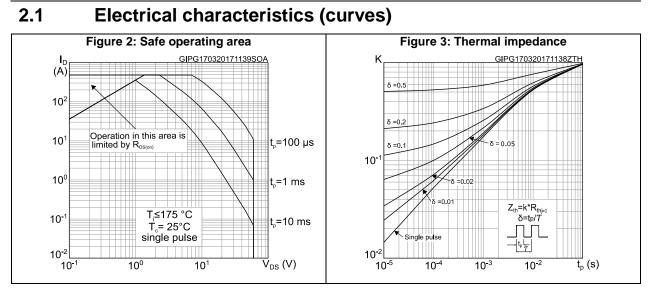
#### Electrical characteristics

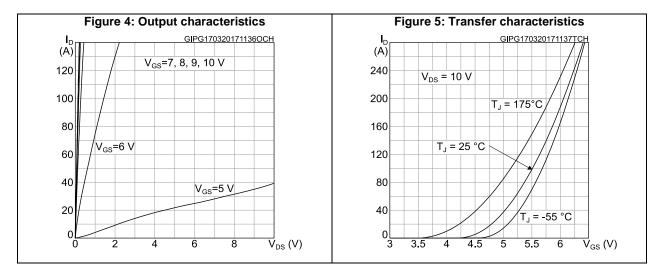
	Table 7: Source-drain diode						
Symbol	Parameter Test conditions		Min.	Тур.	Max.	Unit	
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	I <sub>SD</sub> = 60 A, V <sub>GS</sub> = 0 V	-		1.2	V	
trr	Reverse recovery time	I <sub>D</sub> = 60 A, di/dt = 100 A/µs	-	69		ns	
Qrr	Reverse recovery charge	V <sub>DD</sub> = 48 V (see <i>Figure 15: "Test circuit for</i>		103		nC	
Irrm	Reverse recovery current	inductive load switching and diode recovery times").	-	3		А	

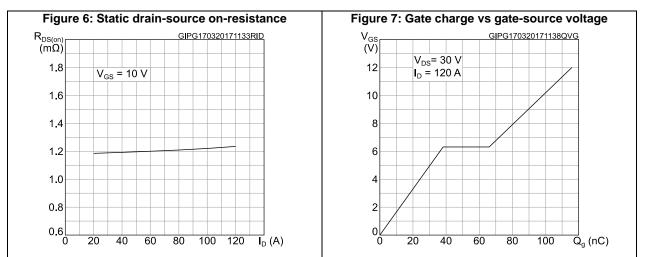
#### Notes:

 $^{(1)}\text{Pulsed:}$  pulse duration = 300  $\mu\text{s},$  duty cycle 1.5%







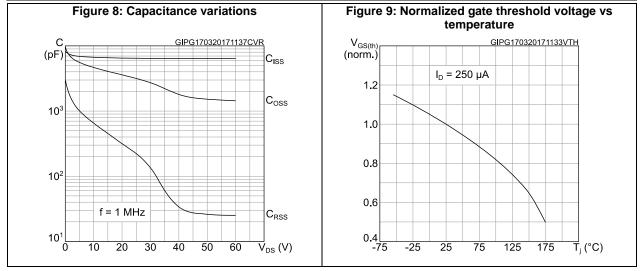


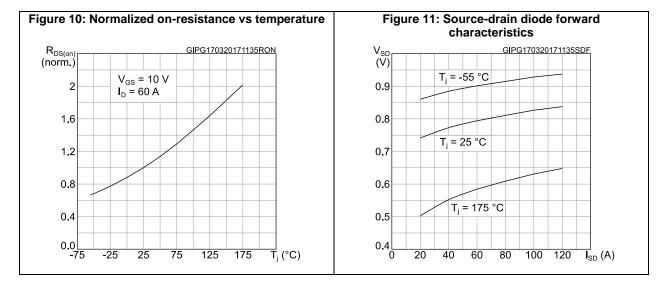
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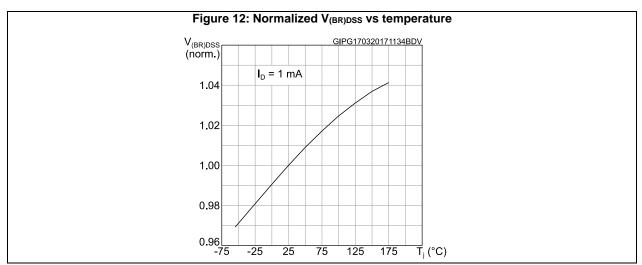


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#### **Electrical characteristics**

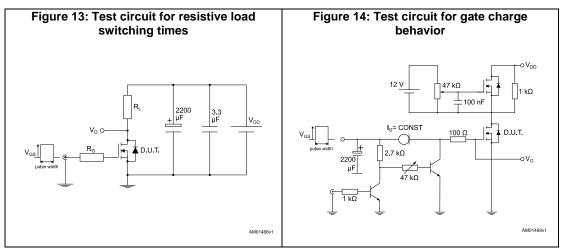


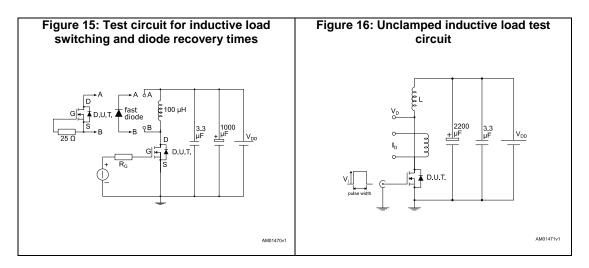


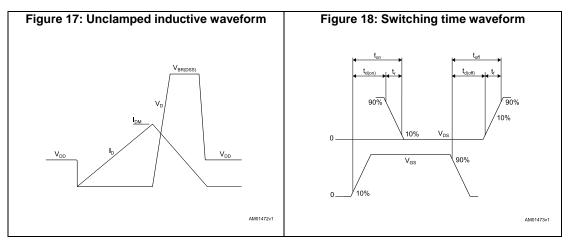


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## 3 Test circuits









## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 4.1 PowerFLAT 5x6 package mechanical data

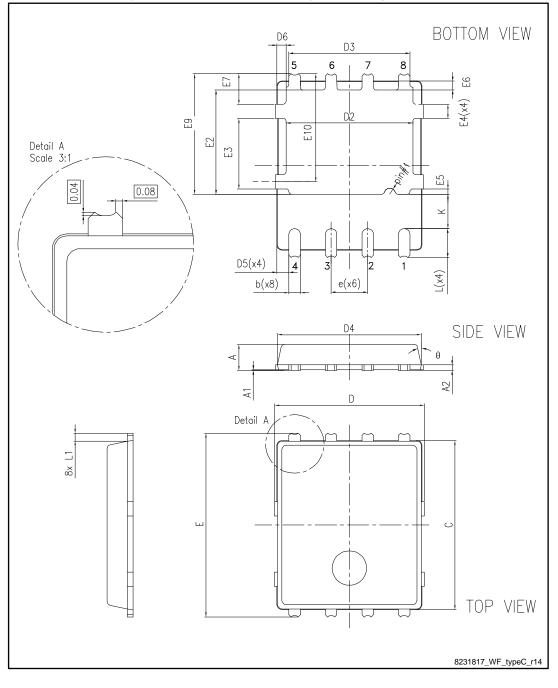


Figure 19: PowerFLAT™ 5x6 WF type C package outline





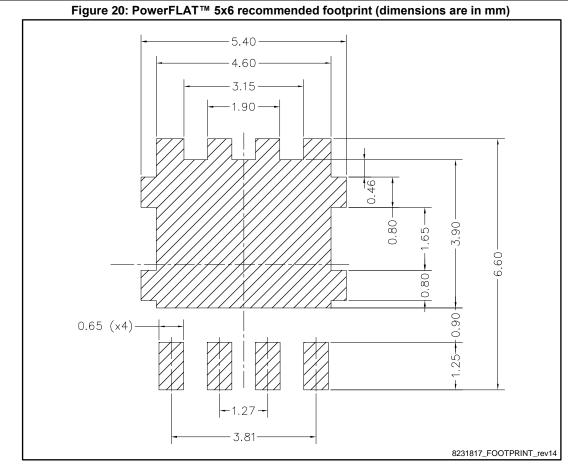
#### Package mechanical data

#### STL225N6F7AG

nechanical data	chanical data STL225N6F7AG				
T	able 8: PowerFLAT™ 5x6	6 WF type C mechanical	data		
Dim.		mm			
Dini.	Min.	Тур.	Max.		
A	0.80		1.00		
A1	0.02		0.05		
A2		0.25			
b	0.30		0.50		
С	5.80	6.00	6.10		
D	5.00	5.20	5.40		
D2	4.15		4.45		
D3	4.05	4.20	4.35		
D4	4.80	5.00	5.10		
D5	0.25	0.40	0.55		
D6	0.15	0.30	0.45		
е		1.27			
E	6.20	6.40	6.60		
E2	3.50		3.70		
E3	2.35		2.55		
E4	0.40		0.60		
E5	0.08		0.28		
E6	0.20	0.325	0.45		
E7	0.85	1.00	1.15		
E9	4.00	4.20	4.40		
E10	3.55	3.70	3.85		
К	1.05		1.35		
L	0.90	1.00	1.10		
L1	0.175	0.275	0.375		
θ	0°		12°		



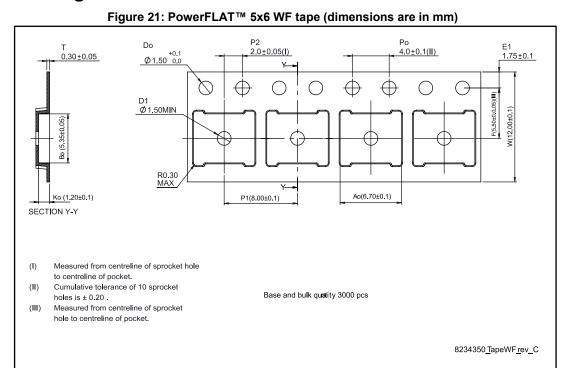
Package mechanical data



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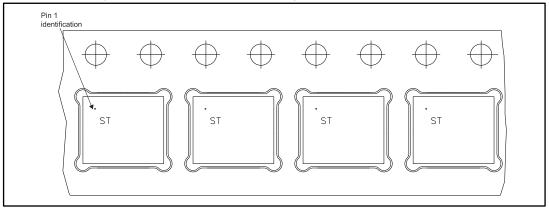
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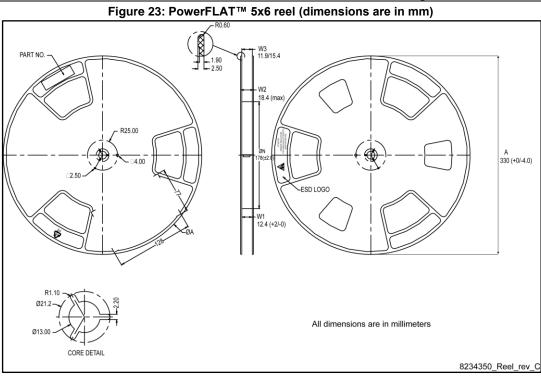


#### 4.2 Packing information

Figure 22: PowerFLAT™ 5x6 package orientation in carrier tape









## 5 Revision history

Table 9: Document revision history

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Date	Revision	Changes
23-Oct-2015	1	First release.
09-Jun-2016	2	Updated title and features in cover page. Updated Table 2: "Absolute maximum ratings", Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode" Minor text changes.
17-Mar-2017	3	Datasheet promoted from preliminary data to production data. Modified title and features on cover page. Modified Table 2: "Absolute maximum ratings". Modified Table 5: "Dynamic", Table 6: "Switching times" and Table 7: "Source-drain diode". Added Section 2.1: "Electrical characteristics (curves)". Minor text changes.



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